



12500 TI Boulevard, MS 8640, Dallas, Texas 75243

**Notification# 20171107002
Datasheet AM26LV32, AM26LV32I
Change Notification**

Date: November 13, 2017
To: TOKYO ELECTRON DEVICE (DSTR) PCN

Dear Customer:

This is a notice of change to a product data sheet for a device that is currently offered by Texas Instruments. The details of this change are on the following pages.

We request you acknowledge receipt of this notification within **30** days of the date of this notice.

The proposed first ship date is indicated on page 3 of this notification, unless customer agreement has been reached on an earlier implementation of the change.

This notice does not change the end-of-life status of any product. Should product affected be on a previously issued product withdrawal/discontinuance notice, this notification does not extend the life of that product or change the life time buy offering/discontinuance plan.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Manager (PCN_ww_admin_team@list.ti.com).

Sincerely,

PCN Team
SC Business Services

20171107002
Data Sheet Change Notification
Attachments

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
AM26LV32CD	null
AM26LV32CDG4	null
AM26LV32CDR	null
AM26LV32CNSR	null
AM26LV32IDR	null
AM26LV32CDRG4	null

Technical details of this Product Change follow on the next page(s).

PCN Number:	20171107002	PCN Date:	November 13, 2017
Title:	Datasheet for AM26LV32, AM26LV32I□		
Customer Contact:	PCN Manager	Dept:	Quality Services
Proposed 1st Ship Date:	February 13, 2018		
Change Type:			
<input type="checkbox"/> Assembly Site	<input type="checkbox"/> Design	<input type="checkbox"/> Wafer Bump Site	
<input type="checkbox"/> Assembly Process	<input checked="" type="checkbox"/> Data Sheet	<input type="checkbox"/> Wafer Bump Material	
<input type="checkbox"/> Assembly Materials	<input type="checkbox"/> Part number change	<input type="checkbox"/> Wafer Bump Process	
<input type="checkbox"/> Mechanical Specification	<input type="checkbox"/> Test Site	<input type="checkbox"/> Wafer Fab Site	
<input type="checkbox"/> Packing/Shipping/Labeling	<input type="checkbox"/> Test Process	<input type="checkbox"/> Wafer Fab Materials	
		<input type="checkbox"/> Wafer Fab Process	

Notification Details

Description of Change:

The product datasheet(s) is being updated as summarized below.
The following change history provides further details.

The datasheet number will be changing.



AM26LV32, AM26LV32I

SLLS202G –MAY 1995–REVISED OCTOBER 2017

Changes from Revision F (November 2016) to Revision G

Page

- Changed the MAX value of $t_{sk(p)}$ From: 6 ns To: 14 ns in the *Switching Characteristics* table 5
- Changed the MAX value of $t_{sk(o)}$ From: 6 ns To: 14 ns in the *Switching Characteristics* table 5

The datasheet number will be changing.

Device Family	Change From:	Change To:
AM26LV32, AM26LV32I	SLLS202F	SLLS202G

These changes may be reviewed at the datasheet links provided.

<http://www.ti.com/product/AM26LV32>

Reason for Change:

To more accurately reflect device characteristics.

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

Electrical specification performance changes as indicated above.

Changes to product identification resulting from this PCN:

None.

Product Affected:

AM26LV32CD	AM26LV32CDRE4	AM26LV32CNSRG4	AM26LV32IDR
AM26LV32CDE4	AM26LV32CDRG4	AM26LV32ID	AM26LV32INS
AM26LV32CDG4	AM26LV32INSRG4	AM26LV32IDE4	AM26LV32INSG4
AM26LV32CDR	AM26LV32CNSR	AM26LV32IDG4	AM26LV32INSR

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com